<table>
<thead>
<tr>
<th>Layer Name</th>
<th>Board</th>
<th>Rev</th>
<th>Sun Rev: Not In Version Control</th>
</tr>
</thead>
<tbody>
<tr>
<td>Bottom Solder</td>
<td>TIDA_0062B</td>
<td>E1</td>
<td></td>
</tr>
</tbody>
</table>

**Plot Name**: Bottom Solder Mask  
**Generated**: 03/09/2015 08:17:57  
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